

ACTT2S-800ETN

Enhanced, high temperature ACTT power switch

Rev - 01 24 July 2017

Product data sheet

1. General description

Planar passivated AC Thyristor Triac power switch in a TO252 (DPAK) surface mountable plastic package with self-protective capabilities against low and high energy transients. This "series ETN" triac will commutate the full RMS current at the maximum rated junction temperature ($T_{j(max)}$ = 150 °C) without the aid of a snubber. It is used in applications where "high junction operating temperature capability" is required.

2. Features and benefits

- Clamping structure ensuring safe high over-voltage withstand capability
- High junction operating temperature capability (T_{j(max)} = 150 °C)
- High minimum IGT for guaranteed immunity to gate noise
- Full cycle AC conduction
- Over-voltage withstand capability to IEC 61000-4-5
- Pin compatible with standard triacs
- Planar passivated for voltage ruggedness and reliability
- · Protective self turn-on capability for high energy transients
- · Safe clamping capability for low energy over-voltage transients
- Less sensitive gate for high noise immunity
- Triggering in three quadrants only
- Very high immunity to false turn-on by dV/dt and IEC 61000-4-4 fast transient
- Package meets UL94V0 flammability requirement
- Package is RoHS compliant

3. Applications

- AC pumps and fans
- High power solenoids
- Highly inductive, resistive and safety loads
- Large and small appliances (White Goods)
- Applications subject to high temperature (T_{j(max)} = 150 °C)

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values	Unit			
Absolute	Absolute maximum rating						
V _{drm}	repetitive peak off-state voltage		800	V			
I _{T(RMS)}	RMS on-state current	square-wave pulse; T _{mb} ≤ 140 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>	2	A			
I _{TSM}	non-repetitive peak forward current	full sine wave; t_p = 20 ms; $T_{j(init)}$ = 25 °C; Fig. 4; Fig. 5	18	A			
		full sine wave; t_{p} = 16.7 ms; $T_{j(init)}$ = 25 $^{\circ}C$	19.8	А			
Tj	junction temperature		150	°C			

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3Q Triac

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics	· · · ·			-	-
I _{GT}	gate trigger current	$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2+ G+} $ $T_{j} = 25 \text{ °C}; \text{ Fig. 7}$	-	-	10	mA
		V_{D} = 12 V; I _T = 0.1 A; T2+ G- T _j = 25 °C; Fig. 7	-	-	10	mA
		$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2- G-} T_{j} = 25 \text{ °C}; Fig. 7$	-	-	10	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	10	mA
V _T	on-state voltage	I _T = 3 A; T _j = 25 °C; <u>Fig. 10</u>	-	-	2	V
Dynamic	characteristics	· · · ·			-	_
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	500	-	-	V/µs
		V_{DM} = 536 V; T _j = 150 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	200	-	-	V/µs
dl _{com} /dt	rate of change of commutating current		1	-	-	A/ms
		$V_D = 400 \text{ V}; \text{T}_\text{j} = 150 ^\circ\text{C}; \text{I}_{\text{T(RMS)}} = 2 \text{ A}; $ $dV_{\text{com}}/dt = 10 \text{ V}/\mu\text{s}; \text{ gate open circuit}$	1.5	-	-	A/ms
		$V_D = 400 \text{ V}; \text{T}_\text{j} = 150 ^\circ\text{C}; \text{I}_{\text{T(RMS)}} = 2 \text{ A}; $ $dV_{\text{com}}/dt = 1 \text{ V}/\mu\text{s}; \text{ gate open circuit}$	3	-	-	A/ms

5. Pinning information

Table 2. P	Table 2. Pinning information						
Pin	Symbol	Description	Simplified outline	Graphic symbol			
1	T1	main terminal 1	mb	T2T1			
2	T2	main terminal 2		G sym051			
3	G	gate		Symoor			
mb	Τ2	mounting base; main terminal 2	1 3 DPAK (TO252N)				

6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
ACTT2S-800ETN DPAK		plastic single-ended surface-mounted package (DPAK); 3 leads (one lead cropped)	TO252N			

7. Marking

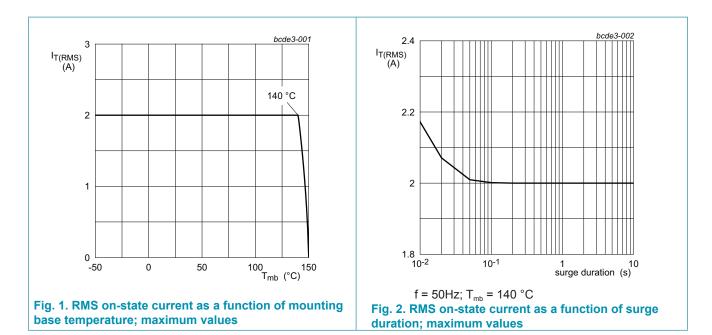
Table 4. Marking codes		
Type number	Marking codes	
ACTT2S-800ETN	ACTT2S-800ETN	
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8. Limiting values

Table 4. Limiting values

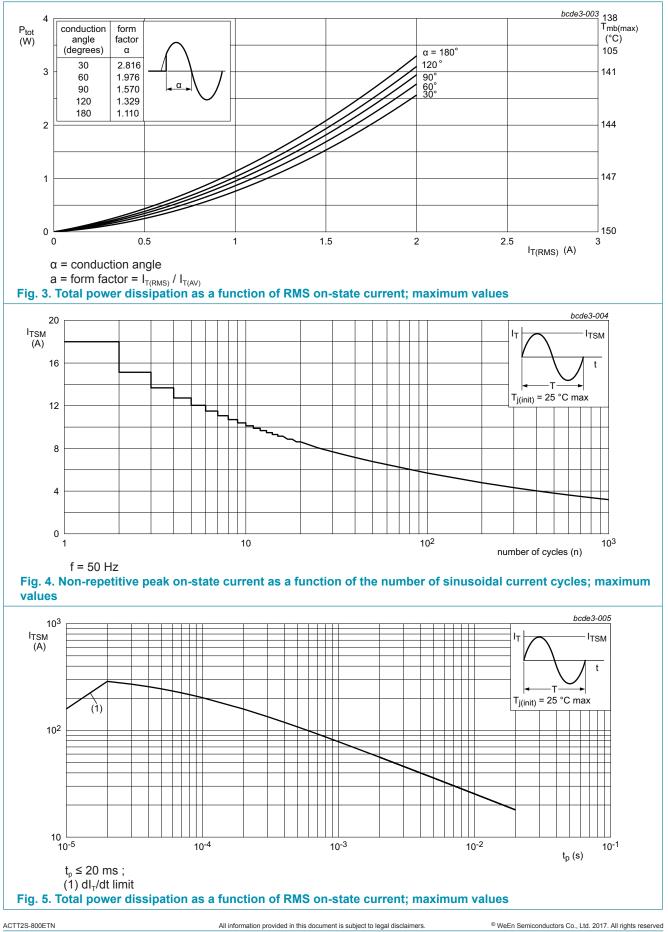
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{DRM}	repetitive peak off-state voltage		800	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{mb} ≤ 140°C; <u>Fig. 1;</u> <u>Fig. 2;</u> <u>Fig. 3</u>	2	A
I _{TSM}	non-repetitive peak on- state current	full sine wave; t_p = 20 ms; $T_{j(init)}$ = 25 °C; Fig. 4; Fig. 5	18	A
		full sine wave; t_p = 16.7 ms; $T_{j(init)}$ = 25 °C	19.8	A
l ² t	l ² t for fusing	t _p = 10ms; sine wave	1.62	A²/s
dl⊤/dt	rate of rise of on-state current	I _G = 70mA	100	A/µs
I _{GM}	peak gate current		2	A
P _{GM}	peak gate power		5	W
P _{G(AV)}	average gate power	over any 20 ms period	0.5	W
T _{stg}	storage temperature		-40 to 150	°C
T _j	junction temperature		150	°C
V_{pp}	peak pulse voltage	T_j = 25 °C; non-repetitive, off-state; ten pulses on each voltage polarity; 20s or more between successive pulses	2	kV



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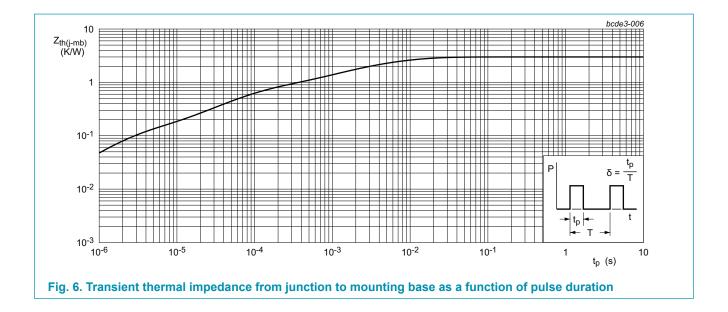
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3Q Triac

9. Thermal characteristics

Table 5. Thermal characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	<u>Fig. 6</u>		-	-	3	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air		-	75	-	K/W



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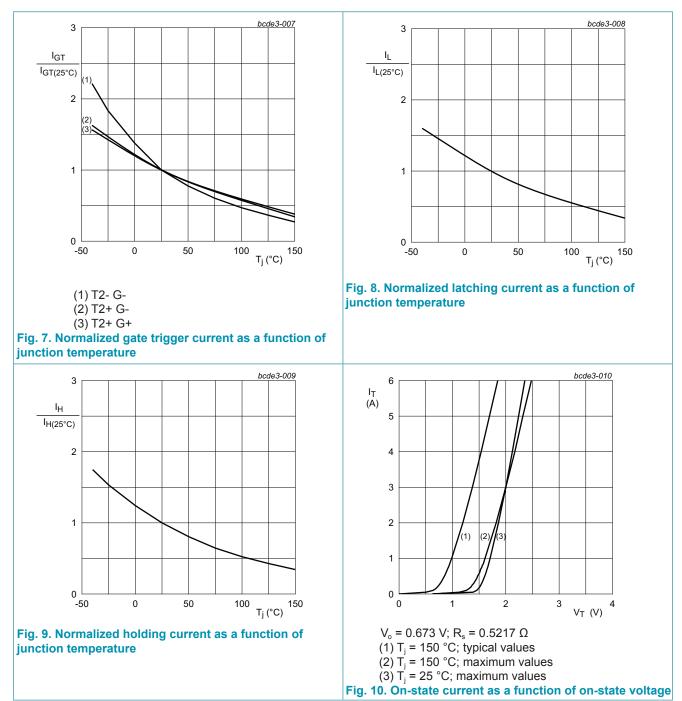
10. Characteristics

	aracteristics	Conditions	Min	Tun	Mox	Unit
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
	racteristics					
I _{GT}	gate trigger current	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2+ G+};$ $T_{j} = 25 \text{ °C}; \text{ Fig. 7}$	-	-	10	mA
		$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T2+ G-};$ T _j = 25 °C; Fig. 7	-	-	10	mA
		$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T2- G-};$ T _j = 25 °C; Fig. 7	-	-	10	mA
l	latching current	$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T2+ G+};$ $T_j = 25 \text{ °C}; \text{ Fig. 8}$	-	-	25	mA
		$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T2+ G-};$ $T_j = 25 \text{ °C}; \text{ Fig. 8}$	-	-	35	mA
		$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T2- G-};$ $T_j = 25 \text{ °C}; \text{ Fig. 8}$	-	-	25	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	10	mA
V _T	on-state voltage	I _T = 3 A; T _j = 25 °C; <u>Fig. 10</u>	-	-	2	V
V _{gt}	gate trigger voltage	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T}_{j} = 25 \text{ °C};$ Fig. 11	-	0.8	1	V
		$V_{D} = 400 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T}_{j} = 150 \text{ °C};$ Fig. 11	0.2	0.45	-	V
I _D	off-state current	$V_{\rm D}$ = 800 V; T _j = 25 °C	-	-	10	μA
		V _D = 800 V; T _j = 150 °C	-	-	2	mA
Dynamic o	haracteristics					
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	500	-	-	V/µs
		V_{DM} = 536 V; T _j = 150 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	200	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	$V_D = 400 \text{ V}; \text{ T}_j = 150 \text{ °C}; \text{ I}_{T(RMS)} = 2 \text{ A};$ $dV_{com}/dt = 20 \text{ V}/\mu\text{s}; \text{ gate open circuit};$ snubberless condition	1	-	-	A/ms
		V_{D} = 400 V; T _j = 150 °C; I _{T(RMS)} = 2 A; dV _{com} /dt = 10 V/µs; gate open circuit	1.5	-	-	A/ms
		$V_D = 400 \text{ V}; \text{ T}_j = 150 \text{ °C}; \text{ I}_{T(RMS)} = 2 \text{ A};$ $dV_{com}/dt = 10 \text{ V}/\mu\text{s}; \text{ gate open circuit}$	3	-	-	A/ms

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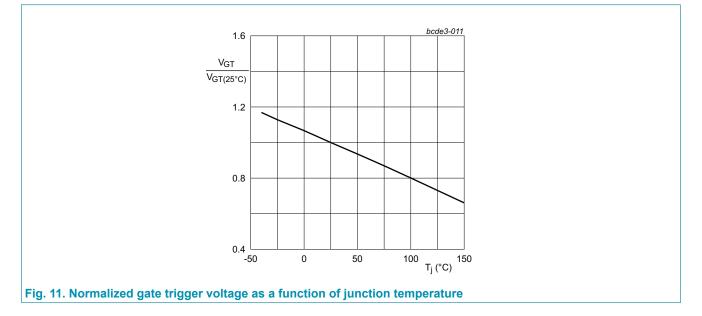
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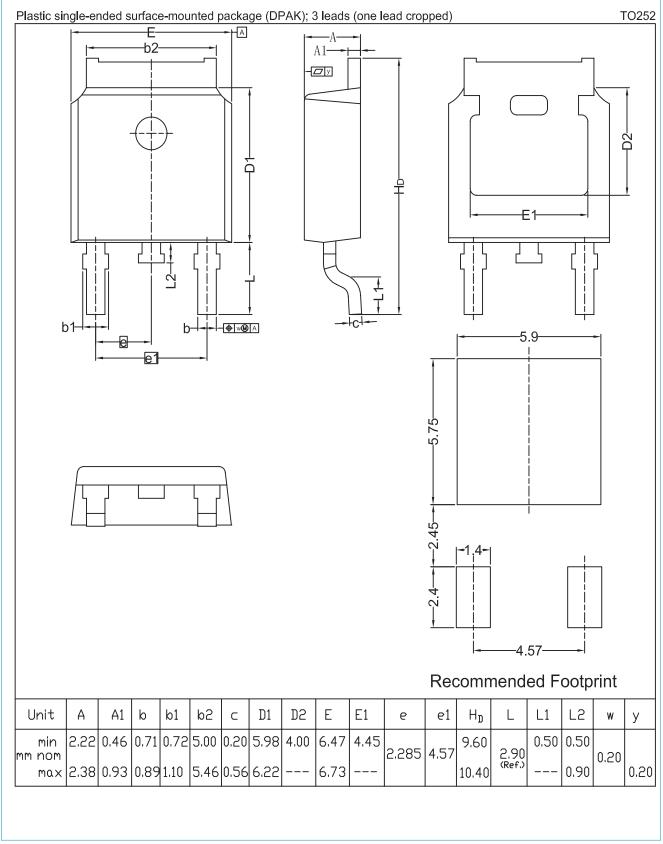
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11. Package outline



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12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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